

Fast Avalanche SMD Rectifier



SMA (DO-214AC)

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low reverse current
- Soft recovery characteristics
- Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	1.5 A
V_{RRM}	200 V, 400 V, 600 V
I_{FSM}	30 A
I_R	1.0 μ A
V_F	1.25 V
t_{rr}	140 ns
E_R	20 mJ
T_J max.	150 °C
Package	SMA (DO-214AC)
Diode variation	Single

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,...)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	BYG24D	BYG24G	BYG24J	UNIT
Device marking code		BYG24D	BYG24G	BYG24J	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Average forward current at $T_A = 65$ °C	$I_{F(AV)}$	1.5			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	30			A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1$ A, $T_J = 25$ °C	E_R	20			mJ
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150			°C



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYG24D	BYG24G	BYG24J	UNIT
Minimum breakdown voltage	I _R = 100 μA		V _{BR}	200	400	600	V
Maximum instantaneous forward voltage	I _F = 1 A	T _J = 25 °C	V _F ⁽¹⁾	1.15			V
	I _F = 1.5 A			1.25			
Maximum reverse current	V _R = V _{RRM}	T _J = 25 °C	I _R	1			μA
		T _J = 100 °C		10			
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	140			ns

Note(1) Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG24D	BYG24G	BYG24J	UNIT
Junction to case	R _{θJC}	25			°C/W
Maximum thermal resistance, junction to ambient	R _{θJA} ⁽¹⁾	150			°C/W
	R _{θJA} ⁽²⁾	125			

Notes(1) Mounted on epoxy-glass hard tissue 35 μm x 17 mm² cooper area per electrode(2) Mounted on epoxy-glass hard tissue 35 μm x 50 mm² cooper area per electrode

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
BYG24D-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG24D-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG24DHM3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG24DHM3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

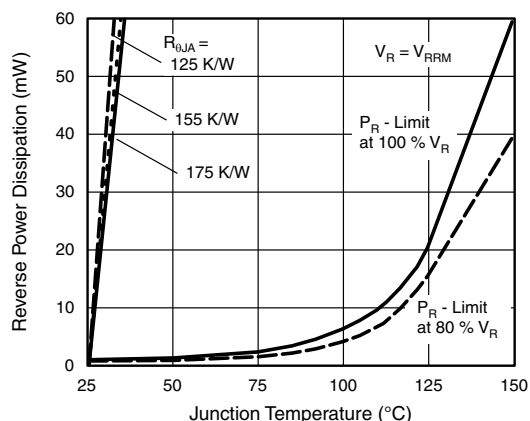
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

Fig. 1 - Max. Reverse Power Dissipation vs. Junction Temperature

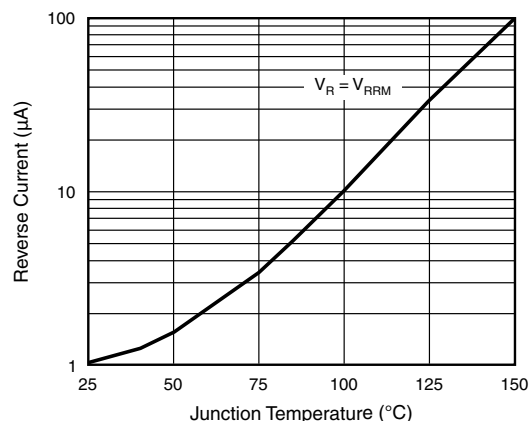


Fig. 2 - Reverse Current vs. Junction Temperature

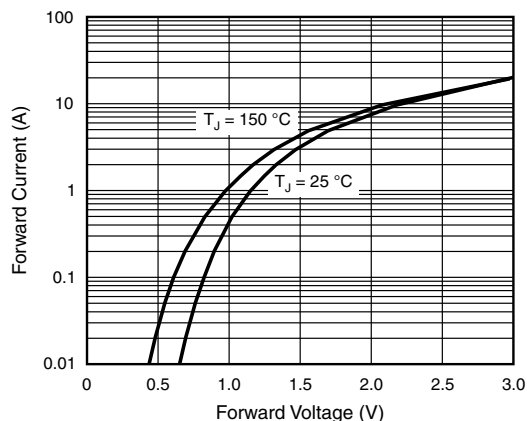


Fig. 3 - Forward Current vs. Forward Voltage

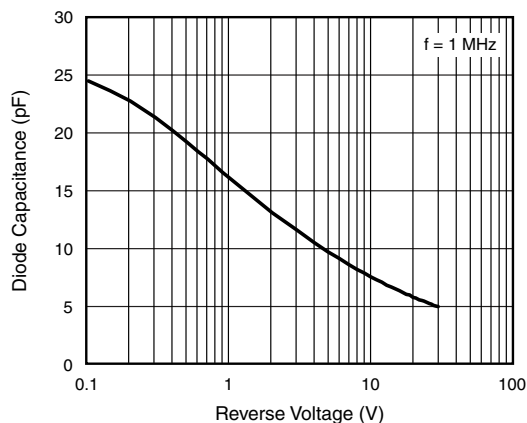


Fig. 5 - Diode Capacitance vs. Reverse Voltage

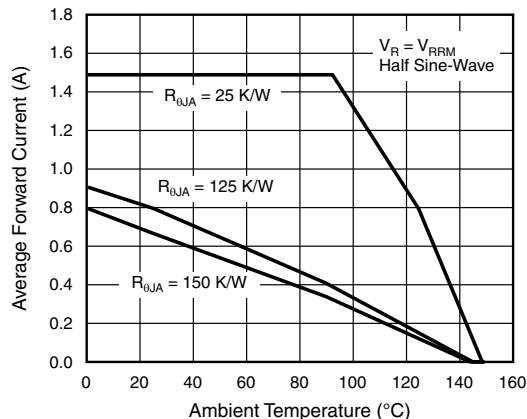
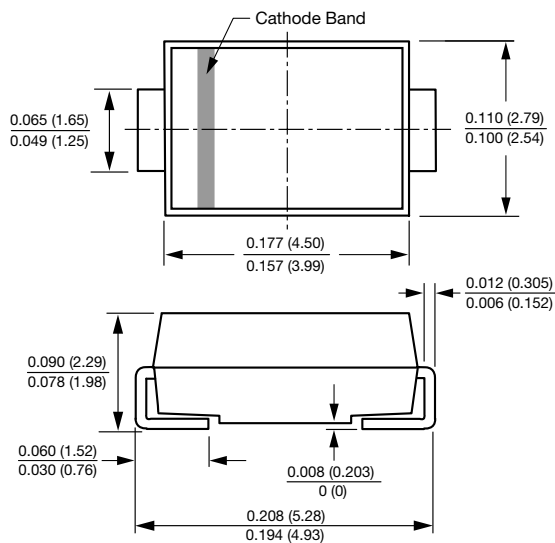


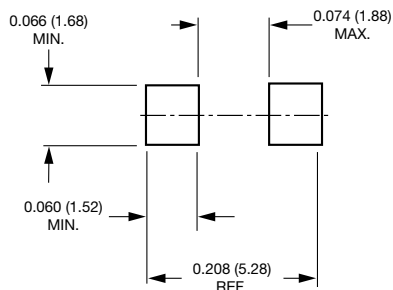
Fig. 4 - Average Forward Current vs. Ambient Temperature

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)



Mounting Pad Layout





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